THE DATASHEET OF

AOT10B65M1

ALPHA & OMEGA SEMICONDUCTOR

AOT10B65M1/AOB10B65M1

650V, 10A Alpha IGBT™

With soft and fast recovery anti-parallel diode

General Description

- Latest AlphaIGBT (α IGBT) technology
- 650V breakdown voltage
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low VCE(SAT) enables high efficiencies
- Low turn-off switching loss and softness
- Very good EMI behavior
- High short-circuit ruggedness

Applications

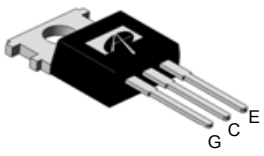
- Motor Drives
- Sewing Machines
- Home Appliances
- Fan, Pumps, Vacuum Cleaner
- Other Hard Switching Applications

Product Summary

V_{CE}	650V
I_C (T_C=100°C)	10A
$V_{CE(sat)}$ (T_J=25°C)	1.6V

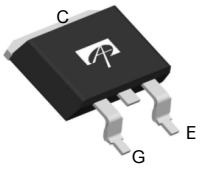
RoHS Compliant

TO-220



AOT10B65M1

TO-263
D²PAK



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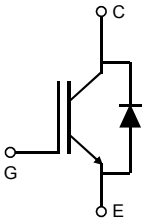

Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT10B65M1	TO220	Tube	1000
AOB10B65M1	TO263	Tape & Reel	800

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOT10B65M1/AOB10B65M1	Units
Collector-Emitter Voltage		V_{CE}	650	V
Gate-Emitter Voltage		V_{GE}	±30	V
Continuous Collector Current	T_C=25°C	I_C	20	A
	T_C=100°C		10	
Pulsed Collector Current, Limited by T_{Jmax}		I_{CM}	30	A
Turn off SOA, V_{CE}≤650V, Limited by T_{Jmax}		I_{LM}	30	A
Continuous Diode Forward Current	T_C=25°C	I_F	20	A
	T_C=100°C		10	
Diode Pulsed Current, Limited by T_{Jmax}		I_{FM}	30	A
Short circuit withstanding time 1) V_{GE}=15V, V_{CC}≤400V, T_J≤175°C		t_{SC}	5	µs
Power Dissipation	T_C=25°C	P_D	150	W
	T_C=100°C		75	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 175	°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T_L	300	°C

Thermal Characteristics

Parameter	Symbol	AOT10B65M1/AOB10B65M1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	65	°C/W
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	1	°C/W
Maximum Diode Junction-to-Case	$R_{\theta JC}$	3.3	°C/W

1) Allowed number of short circuits: <1000; time between short circuits: >1s.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
STATIC PARAMETERS							
BV_{CES}	Collector-Emitter Breakdown Voltage	I_C=1mA, V_{GE}=0V, T_J=25°C		650	-	-	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V_{GE}=15V, I_C=10A	T_J=25°C	-	1.6	2	V
			T_J=125°C	-	1.86	-	
			T_J=175°C	-	2.02	-	
V_F	Diode Forward Voltage	V_{GE}=0V, I_C=10A	T_J=25°C	-	1.9	2.4	V
			T_J=125°C	-	1.96	-	
			T_J=175°C	-	1.91	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	V_{CE}=5V, I_C=1mA		-	5.1	-	V
I_{CES}	Zero Gate Voltage Collector Current	V_{CE}=650V, V_{GE}=0V	T_J=25°C	-	-	10	µA
			T_J=125°C	-	-	100	
			T_J=175°C	-	-	1000	
I_{GES}	Gate-Emitter leakage current	V_{CE}=0V, V_{GE}=±30V		-	-	±100	nA
g_{FS}	Forward Transconductance	V_{CE}=20V, I_C=10A		-	9	-	S
DYNAMIC PARAMETERS							
C_{ies}	Input Capacitance	V_{GE}=0V, V_{CC}=25V, f=1MHz		-	655	-	pF
C_{oes}	Output Capacitance			-	68	-	pF
C_{res}	Reverse Transfer Capacitance			-	25	-	pF
Q_g	Total Gate Charge	V_{GE}=15V, V_{CC}=520V, I_C=10A		-	24	-	nC
Q_{ge}	Gate to Emitter Charge			-	5.5	-	nC
Q_{gc}	Gate to Collector Charge			-	12	-	nC
$I_{C(SC)}$	Short circuit collector current	V_{GE}=15V, V_{CC}=400V, $t_{sc}\leqslant$5us, $T_J\leqslant$175°C		-	70	-	A
R_g	Gate resistance	V_{GE}=0V, V_{CC}=0V, f=1MHz		-	5.8	-	Ω
SWITCHING PARAMETERS, (Load Inductive, T_J=25°C)							
$t_{D(on)}$	Turn-On DelayTime	T_J=25°C, V_{GE}=15V, V_{CC}=400V, I_C=10A, R_G=30Ω		-	12	-	ns
t_r	Turn-On Rise Time			-	16	-	ns
$t_{D(off)}$	Turn-Off Delay Time			-	91	-	ns
t_f	Turn-Off Fall Time			-	14	-	ns
E_{on}	Turn-On Energy			-	0.18	-	mJ
E_{off}	Turn-Off Energy			-	0.13	-	mJ
E_{total}	Total Switching Energy			-	0.31	-	mJ
t_{rr}	Diode Reverse Recovery Time	T_J=25°C, I_F=10A, di/dt=200A/µs, V_{CC}=400V		-	263	-	ns
Q_{rr}	Diode Reverse Recovery Charge			-	0.4	-	µC
I_{rm}	Diode Peak Reverse Recovery Current			-	3.8	-	A
SWITCHING PARAMETERS, (Load Inductive, T_J=175°C)							
$t_{D(on)}$	Turn-On DelayTime	T_J=175°C, V_{GE}=15V, V_{CC}=400V, I_C=10A, R_G=30Ω		-	10	-	ns
t_r	Turn-On Rise Time			-	17	-	ns
$t_{D(off)}$	Turn-Off Delay Time			-	111	-	ns
t_f	Turn-Off Fall Time			-	26	-	ns
E_{on}	Turn-On Energy			-	0.2	-	mJ
E_{off}	Turn-Off Energy			-	0.23	-	mJ
E_{total}	Total Switching Energy			-	0.43	-	mJ
t_{rr}	Diode Reverse Recovery Time	T_J=175°C, I_F=10A, di/dt=200A/µs, V_{CC}=400V		-	262	-	ns
Q_{rr}	Diode Reverse Recovery Charge			-	0.7	-	µC
I_{rm}	Diode Peak Reverse Recovery Current			-	5	-	A

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

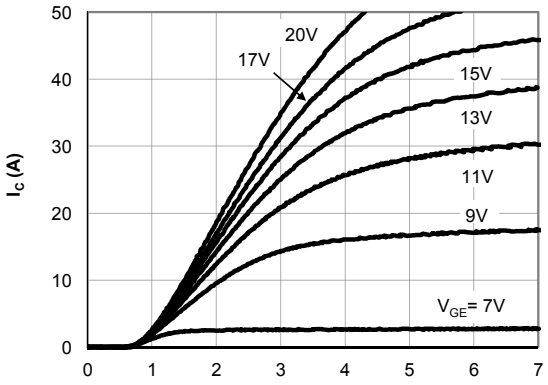

Figure 1: Output Characteristic (T_j=25°C)

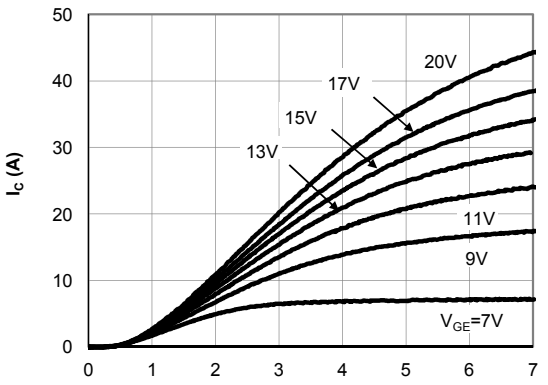

Figure 2: Output Characteristic (T_j=175°C)

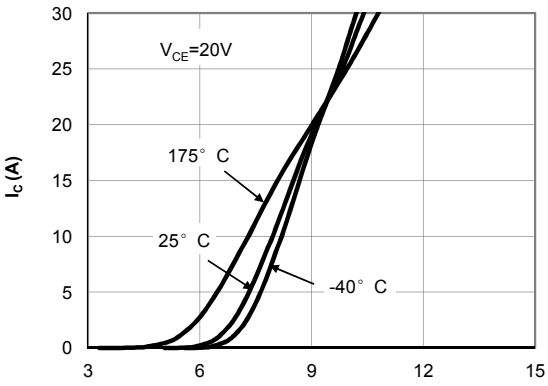

Figure 3: Transfer Characteristic

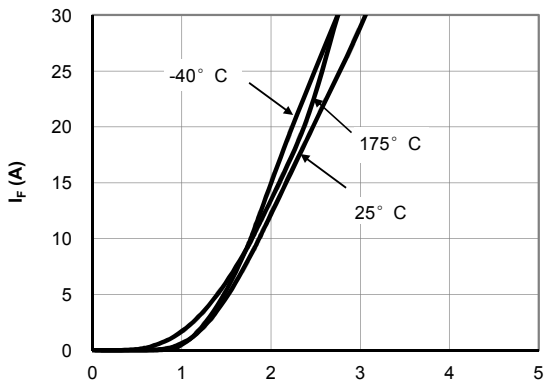

Figure 4: Diode Characteristic

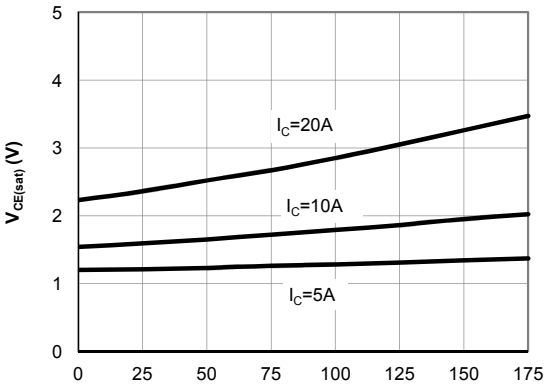

Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

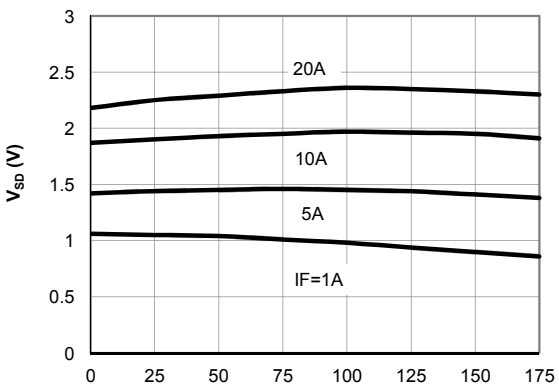

Figure 6: Diode Forward voltage vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

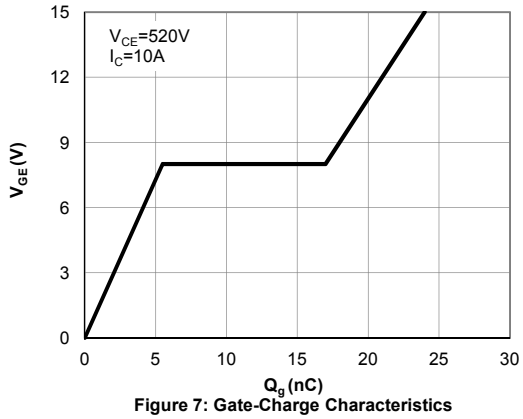

Figure 7: Gate-Charge Characteristics

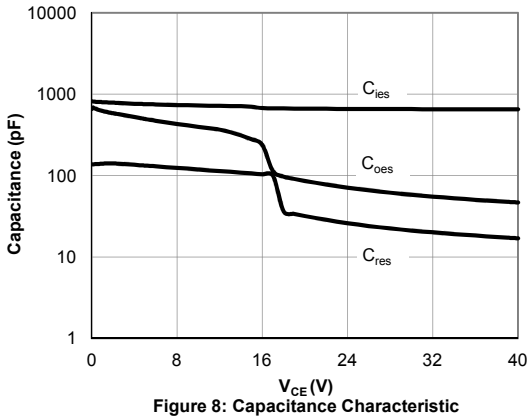

Figure 8: Capacitance Characteristic

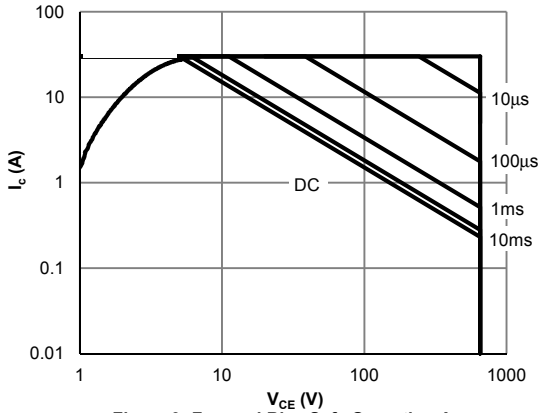

Figure 9: Forward Bias Safe Operating Area
(T_C=25°C, V_{GE}=15V)

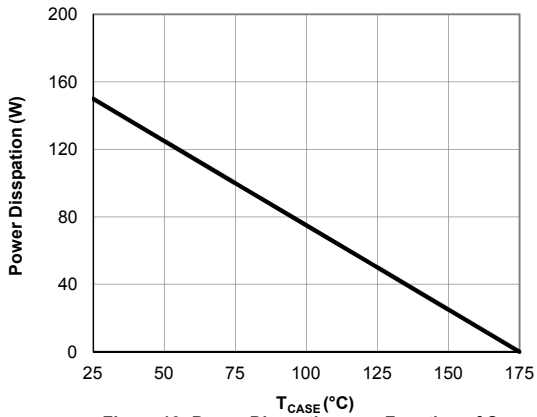

Figure 10: Power Disspation as a Function of Case

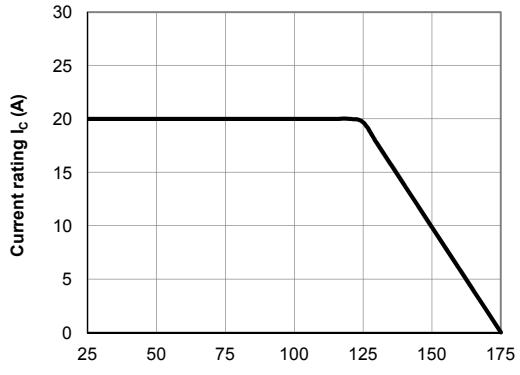

Figure 11: Current De-rating

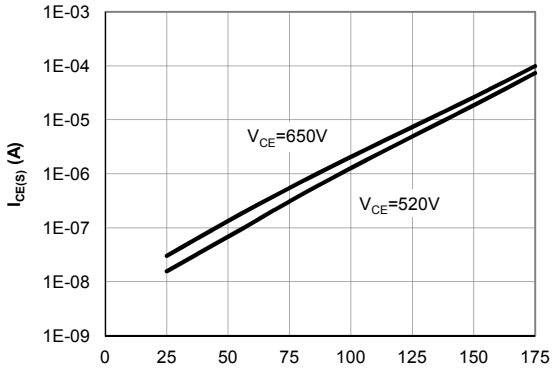

Figure 12: Diode Reverse Leakage Current vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

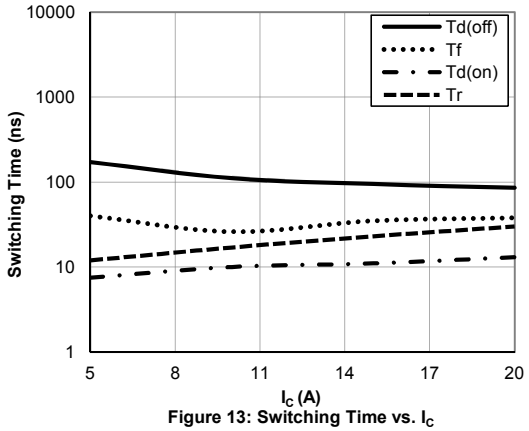

Figure 13: Switching Time vs. I_C
(T_j=175°C, V_{GE}=15V, V_{CE}=400V, R_g=30Ω)

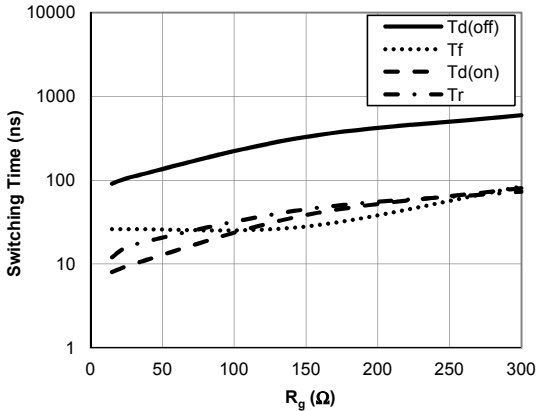

Figure 14: Switching Time vs. R_g
(T_j=175°C, V_{GE}=15V, V_{CE}=400V, I_C=10A)

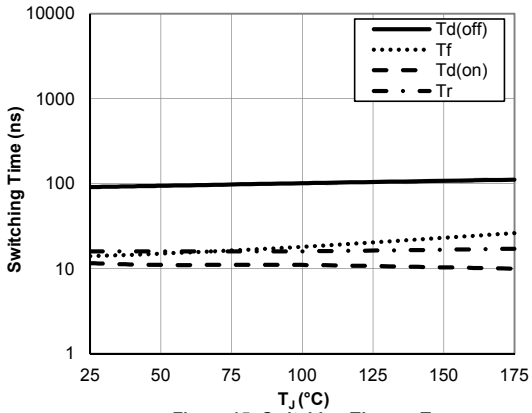

Figure 15: Switching Time vs.T_j
(V_{GE}=15V, V_{CE}=400V, I_C=10A, R_g=30Ω)

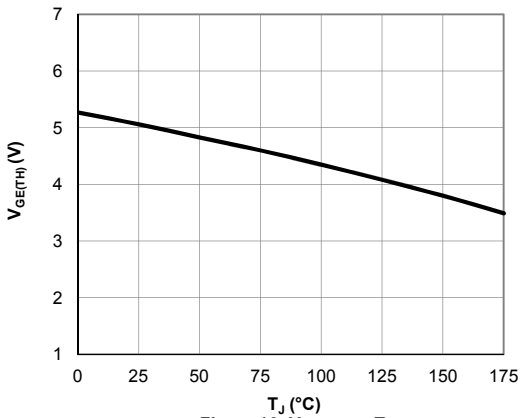

Figure 16: $V_{GE(TH)}$ vs. T_j

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

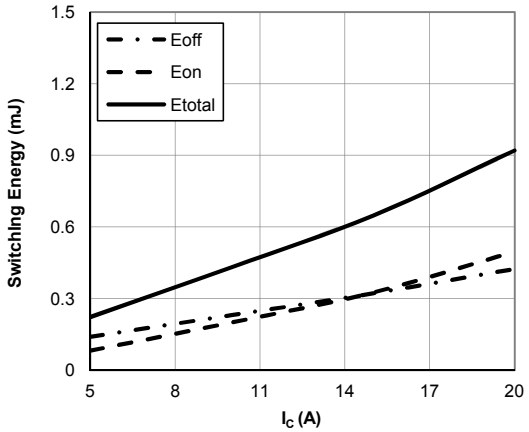

Figure 17: Switching Loss vs. I_C
(T_j=175°C, V_{GE}=15V, V_{CE}=400V, R_g=30Ω)

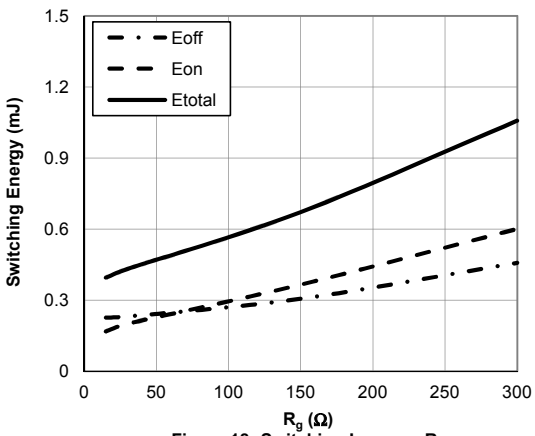

Figure 18: Switching Loss vs. R_g
(T_j=175°C, V_{GE}=15V, V_{CE}=400V, I_C=10A)

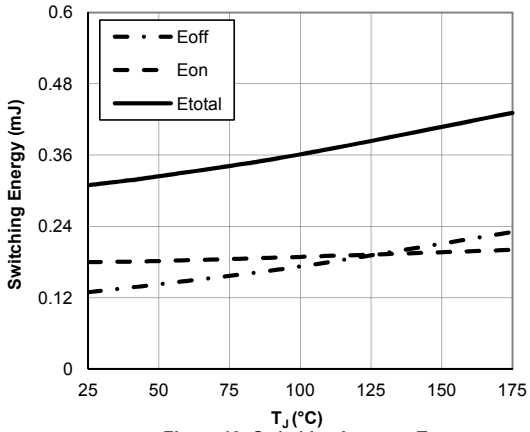

Figure 19: Switching Loss vs. T_j
(V_{GE}=15V, V_{CE}=400V, I_C=10A, R_g=30Ω)

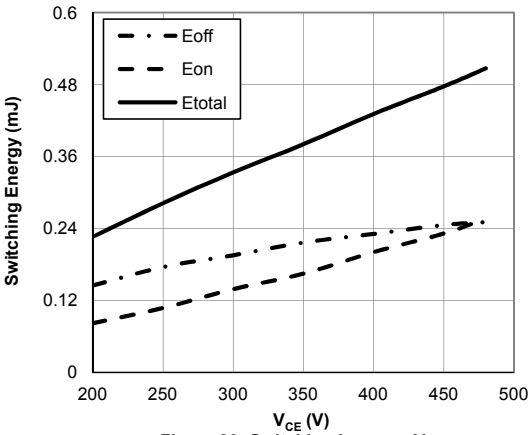

Figure 20: Switching Loss vs. V_{CE}
(T_j=175°C, V_{GE}=15V, I_C=10A, R_g=30Ω)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

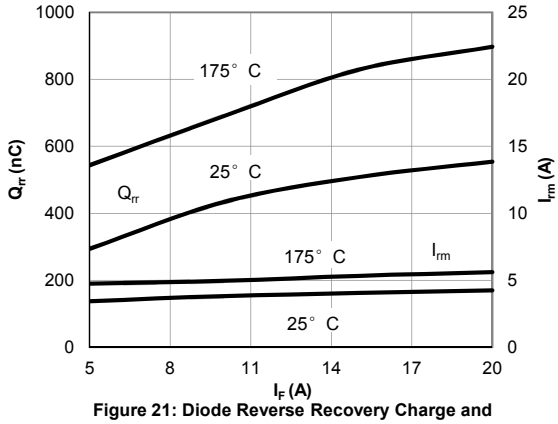

Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current (V_{GE}=15V, V_{CE}=400V, di/dt=200A/µs)

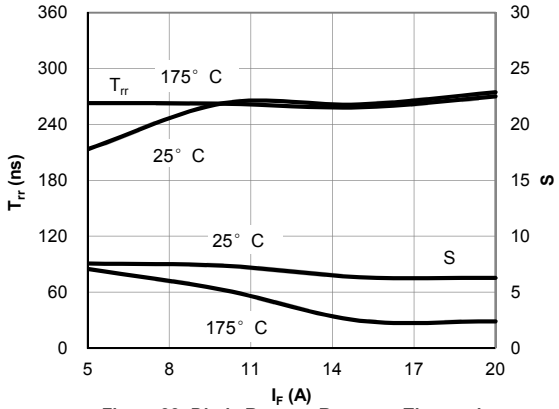

Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current (V_{GE}=15V, V_{CE}=400V, di/dt=200A/µs)

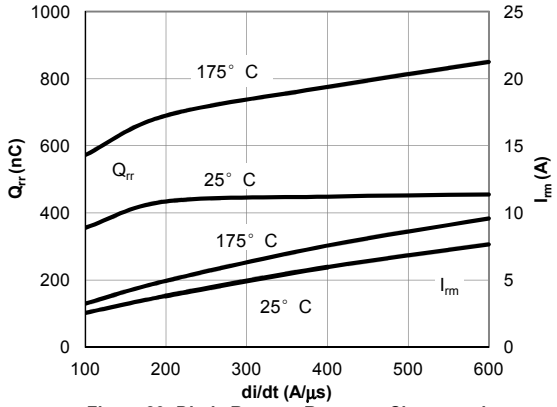

Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt (V_{GE}=15V, V_{CE}=400V, I_F=10A)

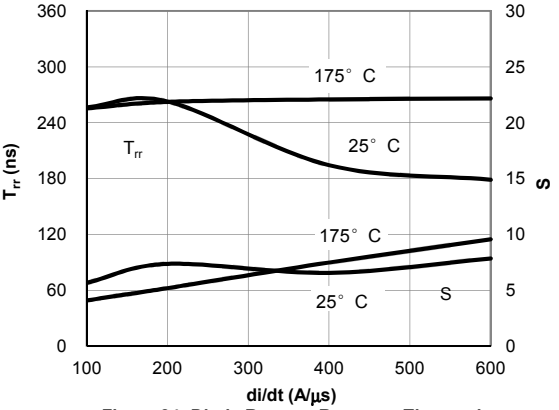

Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt (V_{GE}=15V, V_{CE}=400V, I_F=10A)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

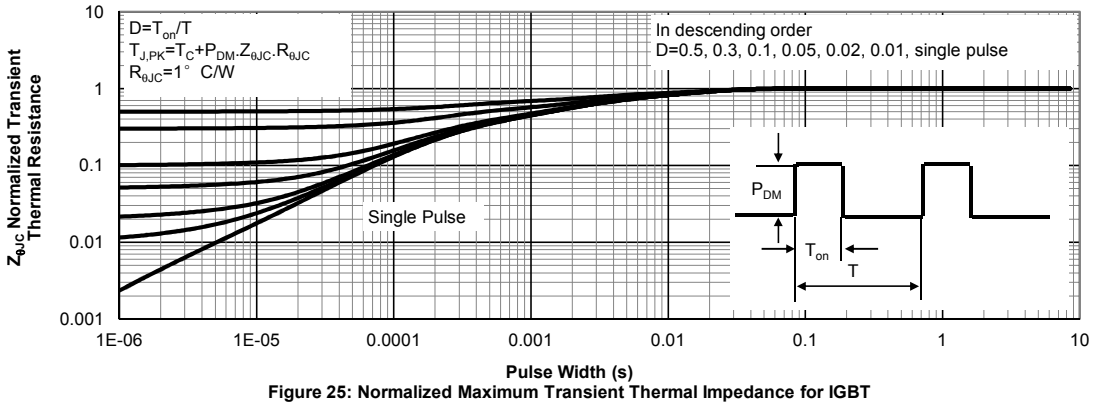

Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT

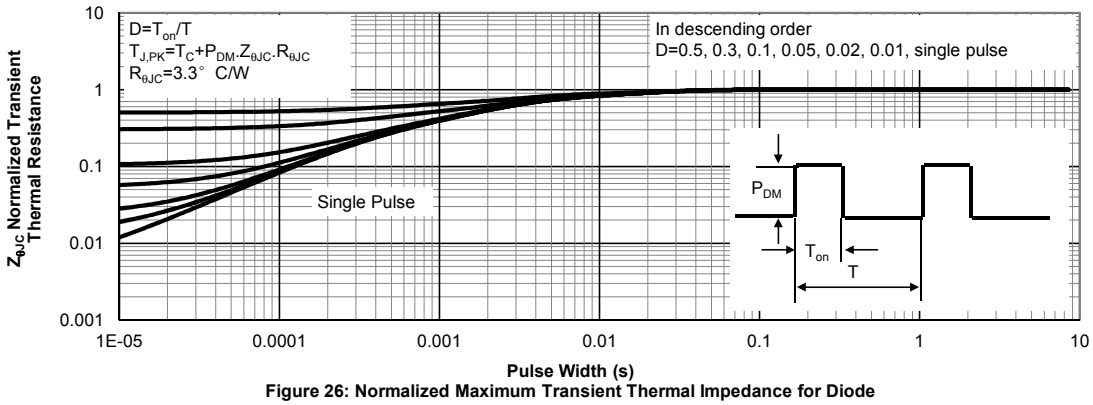

Figure 26: Normalized Maximum Transient Thermal Impedance for Diode

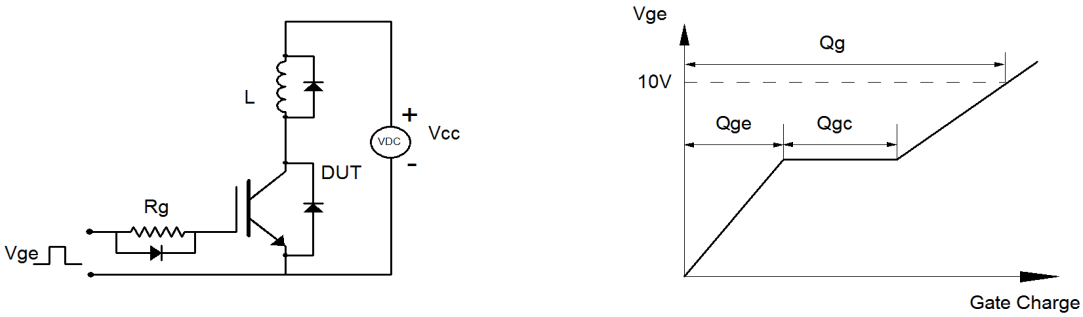

Figure A: Gate Charge Test Circuit & Waveforms

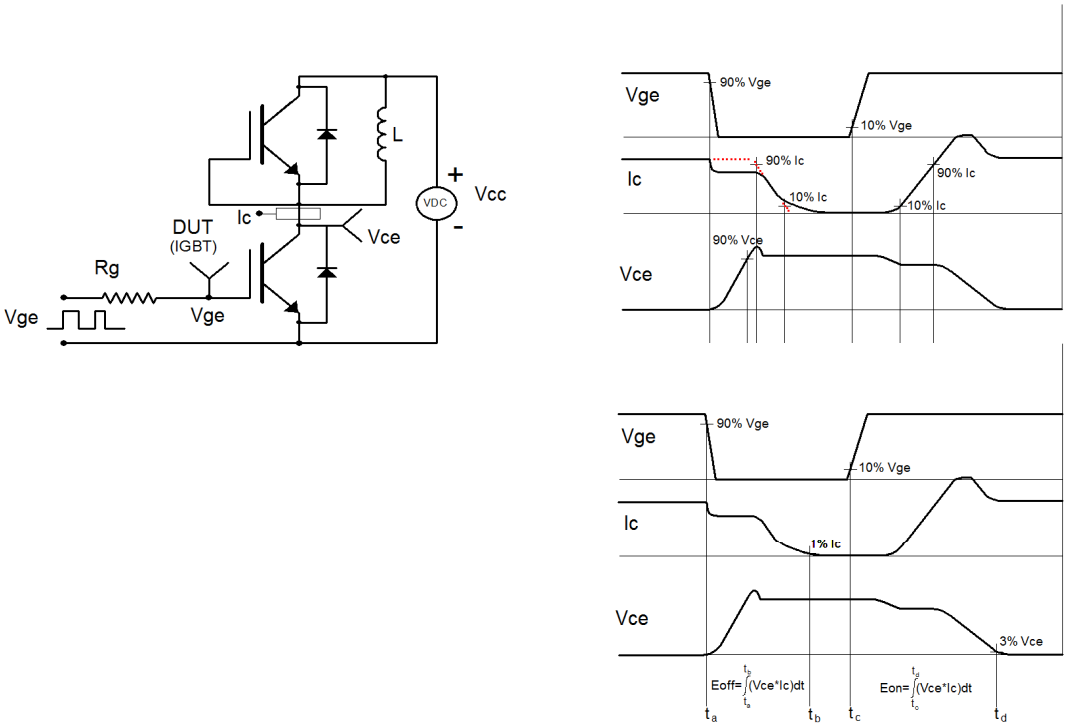

Figure B: Inductive Switching Test Circuit & Waveforms

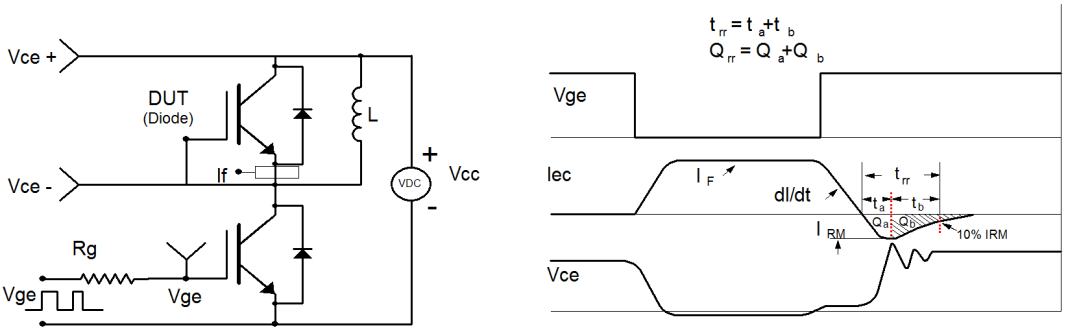

Figure C: Diode Recovery Test Circuit & Waveforms

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